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April 1<sup>st</sup>, 2010 Renesas Electronics Corporation

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# RENESAS

# HD74LS04 / HD74LS05

Hex Inverters / Hex Inverters (with Open Collector Outputs)

REJ03D0391-0300 Rev.3.00 Jul.13.2005

# Features

• Ordering Information

### • HD74LS04

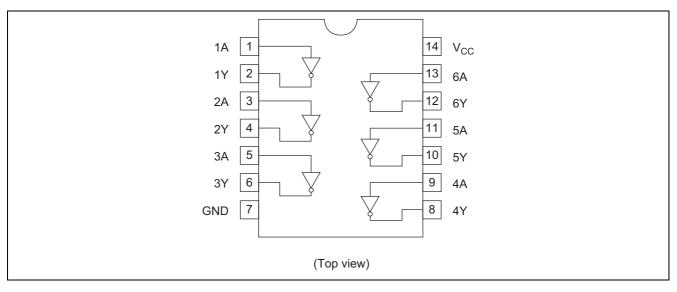
Part Name	Package Type	Package Code (Previous Code)	Package Abbreviation	Taping Abbreviation (Quantity)
HD74LS04P	DILP-14 pin	PRDP0014AB-B (DP-14AV)	Р	_
HD74LS04FPEL	SOP-14 pin (JEITA)	PRSP0014DF-B (FP-14DAV)	FP	EL (2,000 pcs/reel)
HD74LS04RPEL	SOP-14 pin (JEDEC)	PRSP0014DE-A (FP-14DNV)	RP	EL (2,500 pcs/reel)

### • HD74LS05

Part Name	Package Type	Package Code (Previous Code)	Package Abbreviation	Taping Abbreviation (Quantity)
HD74LS05P	DILP-14 pin	PRDP0014AB-B (DP-14AV)	Р	—
HD74LS05FPEL	SOP-14 pin (JEITA)	PRSP0014DF-B (FP-14DAV)	FP	EL (2,000 pcs/reel)
HD74LS05RPEL	SOP-14 pin (JEDEC)	PRSP0014DE-A (FP-14DNV)	RP	EL (2,500 pcs/reel)

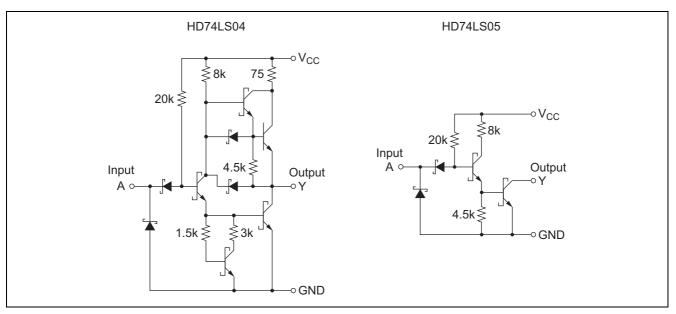
Note: Please consult the sales office for the above package availability.

# **Pin Arrangement**





# **Circuit Schematic (1/6)**



# **Absolute Maximum Ratings**

Item	Symbol	Ratings	Unit
Supply voltage	V <sub>CC</sub> Note	7	V
Input voltage	V <sub>IN</sub>	7	V
Power dissipation	PT	400	mW
Storage temperature	Tstg	-65 to +150	°C

Note: Voltage value, unless otherwise noted, are with respect to network ground terminal.

# **Recommended Operating Conditions**

### • HD74LS04

Item	Symbol	Min	Тур	Max	Unit
Supply voltage	V <sub>CC</sub>	4.75	5.00	5.25	V
Output current	I <sub>OH</sub>	—	—	-400	μA
Output current	I <sub>OL</sub>	—	—	8	mA
Operating temperature	Topr	-20	25	75	°C

#### • HD74LS05

Item	Symbol	Min	Тур	Max	Unit
Supply voltage	Vcc	4.75	5.00	5.25	V
Output voltage	V <sub>OH</sub>	—	—	5.5	V
Output current	I <sub>OL</sub>	—	—	8	mA
Operating temperature	Topr	-20	25	75	°C



## **Electrical Characteristics**

### • HD74LS04

 $(Ta = -20 \text{ to } +75 ^{\circ}\text{C})$ 

Item	Symbol	min.	typ.*	max.	Unit	Condition
Input voltogo	VIH	2.0	—	—	V	
Input voltage	VIL	_	_	0.8	V	
	V <sub>он</sub>	2.7	_	_	V	$V_{CC}$ = 4.75 V, $V_{IL}$ = 0.8 V, $I_{OH}$ = –400 $\mu A$
Output voltage	V	_	_	0.5	V	$I_{OL} = 8 \text{ mA}$ $V_{CC} = 4.75 \text{ V}, \text{ V}_{IH} = 2 \text{ V}$
	V <sub>OL</sub>	_	—	— 0.4 V	v	$I_{OL} = 4 \text{ mA}$ $V_{CC} = 4.75 \text{ V}, \text{ V}_{IH} = 2 \text{ V}$
	I <sub>IH</sub>	_	—	20	μΑ	$V_{CC} = 5.25 \text{ V}, \text{ V}_{I} = 2.7 \text{ V}$
Input current	lı∟	_	—	-0.4	mA	$V_{CC} = 5.25 \text{ V}, \text{ V}_{I} = 0.4 \text{ V}$
	lı lı	_	—	0.1	mA	$V_{CC} = 5.25 \text{ V}, \text{ V}_{I} = 7 \text{ V}$
Short-circuit output current	los	-20	—	-100	mA	V <sub>CC</sub> = 5.25 V
Supply current	I <sub>CCH</sub>	_	1.2	2.4	mA	V <sub>CC</sub> = 5.25 V
	ICCL	_	3.6	6.6	mA	V <sub>CC</sub> = 5.25 V
Input clamp voltage	VIK	_	_	-1.5	V	$V_{CC} = 4.75 \text{ V}, \text{ I}_{IN} = -18 \text{ mA}$

Note:  $* V_{CC} = 5 V$ , Ta =  $25^{\circ}C$ 

#### • HD74LS05

 $(Ta = -20 \text{ to } +75 \text{ }^{\circ}\text{C})$ 

Item	Symbol	min.	typ.*	max.	Unit	Condition
Input voltage	VIH	2.0	—		V	
Input voltage	V <sub>IL</sub>		—	0.8	V	
Output voltage	V <sub>OL</sub>		_	0.5	V	$I_{OL} = 8 \text{ mA}$ $V_{CC} = 4.75 \text{ V}, \text{ V}_{IH} = 2 \text{ V}$
Oulput voltage	V OL	-	—	0.4	V	$I_{OL} = 4 \text{ mA}$ $V_{CC} = 4.75 \text{ V}, \text{ V}_{H} = 2 \text{ V}$
Output current	I <sub>OH</sub>	-	—	100	μΑ	$V_{CC} = 4.75 \text{ V}, V_{IL} = 0.8 \text{ V}, V_{OA} = 5.5 \text{ V}$
	I <sub>IH</sub>	-	—	20	μΑ	$V_{CC} = 5.25 \text{ V}, \text{ V}_{I} = 2.7 \text{ V}$
Input current	IIL	-	—	-0.4	mA	$V_{CC} = 5.25 \text{ V}, \text{ V}_{I} = 0.4 \text{ V}$
	I <sub>I</sub>	-	—	0.1	mA	$V_{CC} = 5.25 \text{ V}, \text{ V}_{I} = 7 \text{ V}$
Supply current	I <sub>CCH</sub>	-	1.2	2.4	mA	V <sub>CC</sub> = 5.25 V
Supply current	I <sub>CCL</sub>	-	3.6	6.6	mA	V <sub>CC</sub> = 5.25 V
Input clamp voltage	V <sub>IK</sub>	_	_	-1.5	V	$V_{CC} = 4.75 \text{ V}, \text{ I}_{IN} = -18 \text{ mA}$

Note:  $V_{CC} = 5 \text{ V}, \text{ Ta} = 25^{\circ}\text{C}$ 

# **Switching Characteristics**

#### • HD74LS04

 $(V_{CC} = 5 V, Ta = 25^{\circ}C)$ 

ltem	Symbol	min.	typ.	max.	Unit	Condition
Dronggation dalay time	t <sub>PLH</sub>	_	9	15	ns	$C_{L} = 15 \text{ pF}, R_{L} = 2 \text{ k}\Omega$
Propagation delay time	t <sub>PHL</sub>		10	15	ns	$C_L = 15 \text{ pF}, R_L = 2 \text{ k}\Omega$

#### • HD74LS05

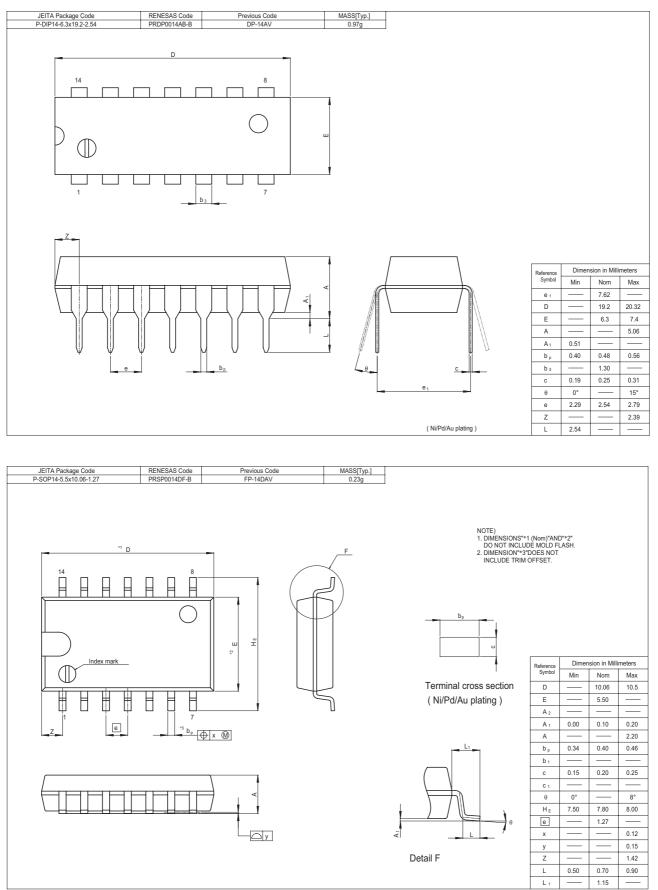
 $(V_{CC} = 5 V, Ta = 25^{\circ}C)$ 

ltem	Symbol	min.	typ.	max.	Unit	Condition
Propagation delay time	t <sub>PLH</sub>	—	17	32	ns	$C_{1} = 15 \text{ pc} = 0 + 2 \text{ kO}$
	t <sub>PHL</sub>	—	15	28	ns	$C_L = 15 \text{ pF}, R_L = 2 \text{ k}\Omega$

Note: Refer to Test Circuit and Waveform of the Common Item "TTL Common Matter (Document No.: REJ27D0005-0100)".

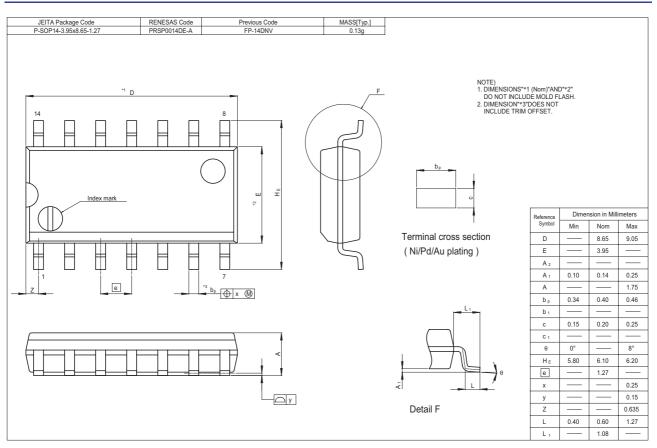


# **Package Dimensions**





## HD74LS04 / HD74LS05





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